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- UBT™ (Universal Bus Transceiver)
   Combines D-Type Latches and D-Type
   Flip-Flops for Operation in Transparent,
   Latched, Clocked, or Clock-Enabled Mode
- State-of-the-Art Advanced BiCMOS
   Technology (ABT) Widebus™ Design for
   2.5-V and 3.3-V Operation and Low
   Static-Power Dissipation
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 2.3-V to 3.6-V V<sub>CC</sub>)
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- High-Drive (-24/24 mA at 2.5-V and -32/64 mA at 3.3-V V<sub>CC</sub>)
- I<sub>off</sub> and Power-Up 3-State Support Hot Insertion
- Use Bus Hold on Data Inputs in Place of External Pullup/Pulldown Resistors to Prevent the Bus From Floating
- Auto3-State Eliminates Bus Current Loading When Output Exceeds V<sub>CC</sub> + 0.5 V
- Flow-Through Architecture Facilitates
   Printed Circuit Board Layout
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package

NOTE: For tape and reel order entry:

The DGGR package is abbreviated to GR and the DGVR package is abbreviated to VR.

### description

The 'ALVTH16601 devices are 18-bit universal bus transceivers designed for 2.5-V or 3.3-V  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment.

The devices combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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# TEXAS INSTRUMENTS

SN54ALVTH16601 . . . WD PACKAGE SN74ALVTH16601 . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)

|                   |      |    | 1                 |
|-------------------|------|----|-------------------|
| OEAB [            | I₁ ∪ | 56 | CLKENAB           |
| LEAB [            | 2    | 55 | CLKAB             |
| A1 [              | 3    | 54 | <u>Б</u> в1       |
| GND [             | 4    | 53 | GND               |
| A2 [              | 5    | 52 | B2                |
| A3 [              | 6    | 51 | ] B3              |
| v <sub>cc</sub> [ | 7    | 50 | ₫ v <sub>cc</sub> |
| A4 [              |      | 49 | ] B4              |
| A5 [              | 9    | 48 | ] B5              |
| A6 [              | 10   | 47 | ] B6              |
| GND [             | 11   | 46 | ] GND             |
| A7 [              | 12   | 45 | <b>]</b> B7       |
| A8 [              | 13   | 44 | ] B8              |
| A9 [              | 14   | 43 | <b>]</b> B9       |
| A10 [             | 15   | 42 | B10               |
| A11 [             | 16   | 41 | B11               |
| A12 [             | 17   | 40 | B12               |
| GND [             | 18   | 39 | ] GND             |
| A13 [             | 19   | 38 | B13               |
| A14 [             | 20   | 37 | B14               |
| A15 [             | 21   | 36 | B15               |
| v <sub>cc</sub> [ | 22   | 35 | ] v <sub>cc</sub> |
| A16 [             | 23   | 34 | B16               |
| A17 [             | 24   | 33 | <b>]</b> B17      |
| GND [             | 25   | 32 | ] GND             |
| A18 [             | 26   | 31 | ] B18             |
| OEBA [            | 27   | 30 | CLKBA_            |
| LEBA [            | 28   | 29 | CLKENBA           |

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### description (continued)

Data flow in each direction is controlled by output-enable ( $\overline{OEAB}$  and  $\overline{OEBA}$ ), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock can be controlled by the clock-enable ( $\overline{CLKENAB}$  and  $\overline{CLKENBA}$ ) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. Output enable  $\overline{OEAB}$  is active low. When  $\overline{OEAB}$  is low, the outputs are active. When  $\overline{OEAB}$  is high, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B, but uses OEBA, LEBA, CLKBA, and CLKENBA.

This device is fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

When  $V_{CC}$  is between 0 and 1.2 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.2 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ALVTH16601 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALVTH16601 is characterized for operation from –40°C to 85°C.

#### **FUNCTION TABLE**†

|         | INPUTS |      |            |   |                                      |  |  |  |
|---------|--------|------|------------|---|--------------------------------------|--|--|--|
| CLKENAB | OEAB   | LEAB | CLKAB      | Α | В                                    |  |  |  |
| Х       | Н      | Χ    | Χ          | Χ | Z                                    |  |  |  |
| Х       | L      | Н    | Χ          | L | L                                    |  |  |  |
| Х       | L      | Н    | Χ          | Н | Н                                    |  |  |  |
| н       | L      | L    | Χ          | X | в <sub>0</sub> ‡                     |  |  |  |
| н       | L      | L    | Χ          | Χ | в <sub>0</sub> ‡<br>в <sub>0</sub> ‡ |  |  |  |
| L       | L      | L    | $\uparrow$ | L | L                                    |  |  |  |
| L       | L      | L    | $\uparrow$ | Н | Н                                    |  |  |  |
| L       | L      | L    | L or H     | X | в <sub>0</sub> ‡                     |  |  |  |

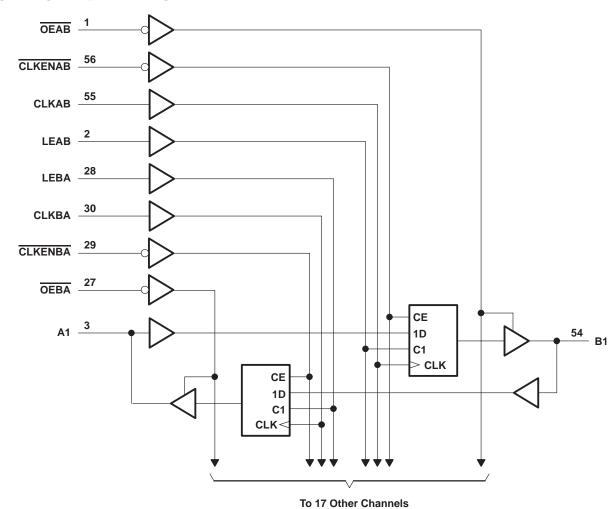
<sup>†</sup> A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, CLKBA, and CLKENBA.



<sup>&</sup>lt;sup>‡</sup> Output level before the indicated steady-state input conditions were established

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### logic diagram (positive logic)





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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>   | 0.5 V to 4.6 V          |
|---|-------------------------|
| Input voltage range, V <sub>I</sub> (see Note 1)  |                         |
| Voltage range applied to any output in the high or power-off state, V <sub>O</sub> (see Note 1) | $-0.5 \text{ V to 7 V}$ |
| Output current in the low state, IO: SN54ALVTH16601   | 96 mA                   |
| SN74ALVTH16601  | 128 mA                  |
| Output current in the high state, I <sub>O</sub> : SN54ALVTH16601                               | –48 mA                  |
| SN74ALVTH16601  | –64 mA                  |
| Input clamp current, $I_{ K }(V_1 < 0)$   | –50 mA                  |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)                                      | –50 mA                  |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package                            |                         |
| DGV package   | 86°C/W                  |
| DL package  | 74°C/W                  |
| Storage temperature range, T <sub>stq</sub>   | -65°C to 150°C          |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

### recommended operating conditions, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (see Note 3)

|                     |  |                 |     | ALVTH1 | 6601 | SN74ALVTH16601 |     |     | UNIT |
|---------------------|--|-----------------|-----|--------|------|----------------|-----|-----|------|
|                     |  |                 |     | TYP    | MAX  | MIN            | TYP | MAX | UNIT |
| VCC                 | Supply voltage                                 |                 | 2.3 |        | 2.7  | 2.3            |     | 2.7 | V    |
| VIH                 | High-level input voltage                       |                 | 1.7 |        | 7    | 1.7            |     |     | V    |
| V <sub>IL</sub>     | Low-level input voltage                        |                 |     | Š      | 0.7  |                |     | 0.7 | V    |
| VI                  | Input voltage                                  |                 | 0   | Vcc    | 5.5  | 0              | VCC | 5.5 | V    |
| loн                 | High-level output current                      |                 |     | 1      | -6   |                |     | -8  | mA   |
| lai                 | Low-level output current                       |                 |     | 2      | 6    |                |     | 8   | mA   |
| lOL                 | Low-level output current; current duty cycle ≤ | 50%; f≥1 kHz    | 20, | 5      | 18   |                |     | 24  | IIIA |
| Δt/Δν               | Input transition rise or fall rate             | Outputs enabled | Q   |        | 10   |                |     | 10  | ns/V |
| Δt/ΔV <sub>CC</sub> | Power-up ramp rate                             |                 | 200 |        |      | 200            |     |     | μs/V |
| T <sub>A</sub>      | Operating free-air temperature                 |                 |     |        | 125  | -40            |     | 85  | °C   |

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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### recommended operating conditions, $V_{\mbox{\footnotesize{CC}}}$ = 3.3 V $\pm$ 0.3 V (see Note 3)

|                     |  |                 | SN54 | ALVTH1 | 6601 | SN74/ | ALVTH1 | 6601 | UNIT |
|---------------------|--|-----------------|------|--------|------|-------|--------|------|------|
|                     |  |                 | MIN  | TYP    | MAX  | MIN   | TYP    | MAX  | UNIT |
| VCC                 | Supply voltage                                 |                 |      |        | 3.6  | 3     |        | 3.6  | V    |
| VIH                 | High-level input voltage                       |                 | 2    |        | 1/2  | 2     |        |      | V    |
| V <sub>IL</sub>     | Low-level input voltage                        |                 |      | Ś      | 0.8  |       |        | 0.8  | V    |
| VI                  | Input voltage                                  |                 | 0    | VCC    | 5.5  | 0     | VCC    | 5.5  | V    |
| IOH                 | High-level output current                      |                 |      | 1      | -24  |       |        | -32  | mA   |
| lai                 | Low-level output current                       |                 |      | 2      | 24   |       |        | 32   | mA   |
| lor                 | Low-level output current; current duty cycle ≤ | 50%; f≥1 kHz    | Q    | 3      | 48   |       |        | 64   | IIIA |
| Δt/Δν               | Input transition rise or fall rate             | Outputs enabled | Q    |        | 10   |       |        | 10   | ns/V |
| Δt/ΔV <sub>CC</sub> | Power-up ramp rate                             |                 | 200  |        |      | 200   |        |      | μs/V |
| TA                  | Operating free-air temperature                 | ·               | -55  |        | 125  | -40   |        | 85   | °C   |

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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### electrical characteristics over recommended operating free-air temperature range, $V_{\text{CC}}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted)

| DA                 | RAMETER        | TEST CO   | ONDITIONS  | SN54               | ALVTH1           | 6601       | SN74  | ALVTH1           | 6601       | UNIT |  |
|--------------------|----------------|---|--|--------------------|------------------|------------|-------|------------------|------------|------|--|
| PA                 | RAWETER        | 1251 00   | NUTTIONS   | MIN                | TYP <sup>†</sup> | MAX        | MIN   | TYP <sup>†</sup> | MAX        | UNIT |  |
| VIK                |                | $V_{CC} = 2.3 \text{ V},$   | $I_I = -18 \text{ mA}$                                 |                    |                  | -1.2       |       |                  | -1.2       | V    |  |
|                    |                | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V},$   | I <sub>OH</sub> = -100 μA                              | V <sub>CC</sub> -0 | .2               |            | VCC-0 | .2               |            |      |  |
| Vон                |                | V <sub>CC</sub> = 2.3 V   | $I_{OH} = -6 \text{ mA}$                               | 1.8                |                  |            |       |                  |            | V    |  |
|                    |                | VCC = 2.5 V   | $I_{OH} = -8 \text{ mA}$                               |                    |                  |            | 1.8   |                  |            |      |  |
|                    |                | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V},$   | $I_{OL} = 100 \mu\text{A}$                             |                    |                  | 0.2        |       |                  | 0.2        |      |  |
|                    |                |   | $I_{OL} = 6 \text{ mA}$                                |                    |                  | 0.4        |       |                  |            |      |  |
| VOL                |                | V <sub>CC</sub> = 2.3 V   | $I_{OL} = 8 \text{ mA}$                                |                    |                  |            |       |                  | 0.4        | V    |  |
|                    |                | VCC = 2.3 V   | I <sub>OL</sub> = 18 mA                                |                    |                  | 0.5        |       |                  |            |      |  |
|                    |                |   | I <sub>OL</sub> = 24 mA                                |                    |                  |            |       |                  | 0.5        |      |  |
| V <sub>RST</sub> ‡ |                | V <sub>CC</sub> = 2.7 V   | $I_O = 1 \text{ mA},$<br>$V_I = V_{CC} \text{ or GND}$ |                    |                  | 0.55       |       |                  | 0.55       | ٧    |  |
|                    | Control innuts | $V_{CC} = 2.7 \text{ V},$   | V <sub>I</sub> = V <sub>CC</sub> or GND                |                    |                  | ±1         |       |                  | ±1         |      |  |
|                    | Control inputs | V <sub>CC</sub> = 0 or 2.7 V,   | V <sub>I</sub> = 5.5 V                                 |                    | 2/4              | 10         |       |                  | 10         |      |  |
| l <sub>l</sub>     |                |   | V <sub>I</sub> = 5.5 V                                 |                    | 7                | 10         |       |                  | 10         | μΑ   |  |
|                    | A or B ports   | V <sub>CC</sub> = 2.7 V   | $V_I = V_{CC}$   |                    | 2                | 1          |       |                  | 1          |      |  |
|                    |                |   | V <sub>I</sub> = 0                                     | C                  | 3                | <b>-</b> 5 |       |                  | <b>–</b> 5 |      |  |
| l <sub>off</sub>   |                | $V_{CC} = 0$ ,  | $V_I$ or $V_O = 0$ to 4.5 $V$                          | 0                  |                  |            |       |                  | ±100       | μΑ   |  |
| I <sub>BHL</sub> § |                | $V_{CC} = 2.3 \text{ V},$   | V <sub>I</sub> = 0.7 V                                 |                    | 115              |            |       | 115              |            | μΑ   |  |
| IBHH               |                | $V_{CC} = 2.3 \text{ V},$   | V <sub>I</sub> = 1.7 V                                 |                    | -10              |            |       | -10              |            | μΑ   |  |
| IBHLO#             | ‡              | $V_{CC} = 2.7 \text{ V},$   | $V_I = 0$ to $V_{CC}$                                  | 300                |                  |            | 300   |                  |            | μΑ   |  |
| Івнно              | I              | $V_{CC} = 2.7 \text{ V},$   | $V_I = 0$ to $V_{CC}$                                  | -300               |                  |            | -300  |                  |            | μΑ   |  |
| lEX☆               |                | $V_{CC} = 2.3 \text{ V},$   | V <sub>O</sub> = 5.5 V                                 |                    |                  | 125        |       |                  | 125        | μΑ   |  |
| I <sub>OZ(PU</sub> | /PD)□          | $V_{CC} \le 1.2 \text{ V}, V_O = \underline{0.5} \text{ V}$<br>$V_I = \text{GND or } V_{CC}, \overline{OE} =$ | to V <sub>CC</sub> ,<br>don't care                     |                    |                  | ±100       |       |                  | ±100       | μА   |  |
|                    |                | V <sub>CC</sub> = 2.7 V,  | Outputs high   |                    | 0.04             | 0.1        |       | 0.04             | 0.1        |      |  |
| ICC                |                | $I_0 = 0,$  | Outputs low  |                    | 2.5              | 4.5        |       | 2.5              | 4.5        | mA   |  |
|                    |                |   | Outputs disabled                                       |                    | 0.04             | 0.1        |       | 0.04             | 0.1        |      |  |
| Ci                 |                | $V_{CC} = 2.5 \text{ V},$   | V <sub>I</sub> = 2.5 V or 0                            |                    | 3                |            |       | 3                |            | pF   |  |
| C <sub>io</sub>    |                | $V_{CC} = 2.5 \text{ V},$   | $V_0 = 2.5 \text{ V or } 0$                            |                    | 7                |            |       | 7                |            | pF   |  |

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 2.5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>&</sup>lt;sup>‡</sup> Data must not be loaded into the flip-flops/latches after applying power.

<sup>§</sup> The bus-hold circuit can sink at least the minimum low sustaining current at V<sub>IL</sub> max. I<sub>BHL</sub> should be measured after lowering V<sub>IN</sub> to GND and then raising it to V<sub>IL</sub> max.

The bus-hold circuit can source at least the minimum high sustaining current at VIH min. IBHH should be measured after raising VIN to VCC and then lowering it to VIH min.

<sup>#</sup> An external driver must source at least I<sub>BHLO</sub> to switch this node from low to high.

An external driver must sink at least IBHHO to switch this node from high to low.

<sup>☆</sup>Current into an output in the high state when V<sub>O</sub> > V<sub>CC</sub>

<sup>□</sup> High-impedance state during power up or power down

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### electrical characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted)

| PARAMETER          |                | TEST (   | CONDITIONS   | SN54               | ALVTH1           | 6601       | SN74                | ALVTH1           | 6601       | UNIT |
|--------------------|----------------|--|--|--------------------|------------------|------------|---------------------|------------------|------------|------|
| Ε/                 | ARAMETER       | lE31 (   | CONDITIONS   | MIN                | TYP <sup>†</sup> | MAX        | MIN                 | TYP <sup>†</sup> | MAX        | UNIT |
| ٧ıK                |                | $V_{CC} = 3 V$   | $I_{I} = -18 \text{ mA}$                               |                    |                  | -1.2       |                     |                  | -1.2       | V    |
|                    |                | $V_{CC} = 3 \text{ V to } 3.6 \text{ V},$  | $I_{OH} = -100  \mu A$                                 | V <sub>CC</sub> -0 | .2               |            | V <sub>CC</sub> -0. | .2               |            |      |
| Vон                |                | V <sub>CC</sub> = 3 V  | $I_{OH} = -24 \text{ mA}$                              | 2                  |                  |            |                     |                  |            | V    |
|                    |                | VCC = 3 V  | $I_{OH} = -32 \text{ mA}$                              |                    |                  |            | 2                   |                  |            |      |
|                    |                | $V_{CC} = 3 \text{ V to } 3.6 \text{ V},$  | I <sub>OL</sub> = 100 μA                               |                    |                  | 0.2        |                     |                  | 0.2        |      |
|                    |                |  | $I_{OL} = 16 \text{ mA}$                               |                    |                  |            |                     |                  | 0.4        |      |
| VOL                |                |  | $I_{OL} = 24 \text{ mA}$                               |                    |                  | 0.5        |                     |                  |            | V    |
| VOL                |                | VCC = 3 V  | $I_{OL} = 32 \text{ mA}$                               |                    |                  |            |                     |                  | 0.5        | v    |
|                    |                |  | $I_{OL} = 48 \text{ mA}$                               |                    |                  | 0.55       |                     |                  |            |      |
|                    |                |  | $I_{OL} = 64 \text{ mA}$                               |                    |                  |            |                     |                  | 0.55       |      |
| V <sub>RST</sub>   | ‡              | V <sub>CC</sub> = 3.6 V  | $I_O = 1 \text{ mA},$<br>$V_I = V_{CC} \text{ or GND}$ |                    |                  | 0.55       |                     |                  | 0.55       | V    |
|                    | Control innuts | V <sub>CC</sub> = 3.6 V,   | V <sub>I</sub> = V <sub>CC</sub> or GND                |                    | 24               | ±1         |                     |                  | ±1         |      |
|                    | Control inputs | $V_{CC} = 0 \text{ or } 3.6 \text{ V},$  | V <sub>I</sub> = 5.5 V                                 |                    | 7                | 10         |                     |                  | 10         |      |
| II                 |                |  | V <sub>I</sub> = 5.5 V                                 |                    | 2                | 10         |                     |                  | 10         | μΑ   |
|                    | A or B ports   | VCC = 3.6 V  | $V_I = V_{CC}$   | Ć                  | 3                | 1          |                     |                  | 1          |      |
|                    |                |  | V <sub>I</sub> = 0                                     | Q                  |                  | <b>-</b> 5 |                     |                  | <b>–</b> 5 |      |
| l <sub>off</sub>   |                | $V_{CC} = 0$ ,   | $V_I$ or $V_O = 0$ to 4.5 $V$                          |                    |                  |            |                     |                  | ±100       | μΑ   |
| I <sub>BHL</sub> § |                | $V_{CC} = 3 V$ ,   | V <sub>I</sub> = 0.8 V                                 | 75                 |                  |            | 75                  |                  |            | μΑ   |
| IBHH               |                | $V_{CC} = 3 V$ ,   | V <sub>I</sub> = 2 V                                   | -75                |                  |            | -75                 |                  |            | μΑ   |
| IBHLO              | ) <sup>#</sup> | $V_{CC} = 3.6 \text{ V},$  | $V_I = 0$ to $V_{CC}$                                  | 500                |                  |            | 500                 |                  |            | μΑ   |
| Івнно              |                | $V_{CC} = 3.6 \text{ V},$  | $V_I = 0$ to $V_{CC}$                                  | -500               |                  |            | -500                |                  |            | μΑ   |
| lEX☆               |                | $V_{CC} = 3 V$   | $V_0 = 5.5 V$  |                    |                  | 125        |                     |                  | 125        | μΑ   |
| I <sub>OZ(PI</sub> | U/PD)□         | $V_{CC} \le 1.2 \text{ V}, V_{O} = \frac{0.5}{\text{OE}}$<br>$V_{I} = \text{GND or } V_{CC}, \overline{\text{OE}}$ | V to V <sub>CC</sub> ,<br>= don't care                 |                    |                  | ±100       |                     |                  | ±100       | μΑ   |
|                    |                | V <sub>CC</sub> = 3.6 V,   | Outputs high   |                    | 0.06             | 0.1        |                     | 0.06             | 0.1        |      |
| ICC                |                | $I_{O}=0$ ,  | Outputs low  |                    | 3.5              | 5          |                     | 3.5              | 5          | mA   |
|                    |                | $V_I = V_{CC}$ or GND  | Outputs disabled                                       |                    | 0.06             | 0.1        |                     | 0.06             | 0.1        |      |
| ∆ICC◊              |                | $V_{CC} = 3 \text{ V to } 3.6 \text{ V, Or}$<br>Other inputs at $V_{CC}$ or  | e input at V <sub>CC</sub> – 0.6 V,<br>GND             |                    |                  | 0.4        |                     |                  | 0.4        | mA   |
| Ci                 |                | $V_{CC} = 3.3 \text{ V},$  | V <sub>I</sub> = 3.3 V or 0                            |                    | 3                |            |                     | 3                |            | pF   |
| C <sub>io</sub>    |                | V <sub>CC</sub> = 3.3 V,   | V <sub>O</sub> = 3.3 V or 0                            |                    | 7                |            |                     | 7                |            | pF   |
|                    |                |  |  |                    |                  |            |                     |                  |            |      |

 $<sup>\</sup>uparrow$  All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.



<sup>&</sup>lt;sup>‡</sup> Data must not be loaded into the flip-flops/latches after applying power.

<sup>§</sup> The bus-hold circuit can sink at least the minimum low sustaining current at V<sub>IL</sub> max. I<sub>BHL</sub> should be measured after lowering V<sub>IN</sub> to GND and then raising it to V<sub>IL</sub> max.

The bus-hold circuit can source at least the minimum high sustaining current at V<sub>IH</sub> min. I<sub>BHH</sub> should be measured after raising V<sub>IN</sub> to V<sub>CC</sub> and then lowering it to V<sub>IH</sub> min.

<sup>#</sup> An external driver must source at least IBHLO to switch this node from low to high.

An external driver must sink at least IBHHO to switch this node from high to low.

 $<sup>\</sup>star$ Current into an output in the high state when  $V_O > V_{CC}$ 

<sup>□</sup> High-impedance state during power up or power down

<sup>♦</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

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### timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

|                 |                          |                    |           | SN54ALVT | H16601 | SN74ALVT | H16601 | UNIT |
|-----------------|--------------------------|--------------------|-----------|----------|--------|----------|--------|------|
|                 |                          |                    |           | MIN      | MAX    | MIN      | MAX    | UNII |
| fclock          | Clock frequency          |                    |           |          | 150    |          | 150    | MHz  |
|                 | Pulse duration           | LE high            |           | 1.8      |        | 1.8      |        | 20   |
| t <sub>W</sub>  | Pulse duration           | CLK high or low    |           | 2.3      |        | 2.3      |        | ns   |
|                 |                          | A B h - ( OL)(^    | Data high | 4        |        | 4        |        |      |
|                 | <sub>Su</sub> Setup time | A or B before CLK↑ | Data low  | 5.2      |        | 5.2      |        |      |
|                 |                          | . 5. ( .5.         | CLK high  | 0.7      | EN     | 0.7      |        |      |
| t <sub>su</sub> |                          | A or B before LE↓  | CLK low   | 0.9      | Ty.    | 0.9      |        | ns   |
| 1               |                          |                    | Data high | 1.7, 0   |        | 1.7      |        |      |
|                 |                          | CLKEN before CLK↑  | Data low  | 2.3      |        | 2.3      |        |      |
|                 |                          | A B - (1 OLK)      | Data high | 0.5      |        | 0.5      |        |      |
|                 |                          | A or B after CLK↑  | Data low  | 0.5      |        | 0.5      |        |      |
|                 |                          | A an D affan I E l | CLK high  | 2.3      |        | 2.3      |        |      |
| th              | Hold time                | A or B after LE↓   | CLK low   | 2.4      |        | 2.4      |        | ns   |
|                 |                          | OLICEN - (1 OLIC   | Data high | 0.5      |        | 0.5      | 5      |      |
|                 |                          | CLKEN after CLK↑   | Data low  | 0.5      |        | 0.5      |        |      |

### timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 2)

|                 |                            |                        |           | SN54ALVT | H16601 | SN74ALVT | H16601 | UNIT |
|-----------------|----------------------------|------------------------|-----------|----------|--------|----------|--------|------|
|                 |                            |                        |           | MIN      | MAX    | MIN      | MAX    | UNII |
| fclock          | Clock frequency            |                        |           |          | 150    |          | 150    | MHz  |
|                 | Dulas direction            | LE high                |           | 1.8      |        | 1.8      |        |      |
| t <sub>W</sub>  | Pulse duration             | CLK high or low        |           | 2.3      |        | 2.3      |        | ns   |
|                 |                            | A == B t = (=== 01.14) | Data high | 2.4      |        | 2.4      |        |      |
|                 |                            | A or B before CLK↑     | Data low  | 3.8      |        | 3.8      |        |      |
| 1.              | t <sub>SU</sub> Setup time | A B b - ( 1 E l        | CLK high  | 1        | EN     | 1        |        |      |
| <sup>t</sup> su |                            | A or B before LE↓      | CLK low   | 0.6      | Ty.    | 0.6      |        | ns   |
|                 |                            |                        | Data high | 1.4,0    |        | 1.4      |        |      |
|                 |                            | CLKEN before CLK↑      | Data low  | 1.9      |        | 1.9      |        |      |
|                 |                            | <b>1</b>               | Data high | 0.5      |        | 0.5      |        |      |
|                 |                            | A or B after CLK↑      | Data low  | 0.5      |        | 0.5      |        |      |
| 1.              | Halden                     | A D - ((   E           | CLK high  | 2        |        | 2        |        |      |
| th              | Hold time                  | A or B after LE↓       | CLK low   | 2.3      |        | 2.3      |        | ns   |
|                 |                            | CLICEN of an OLIC      | Data high | 0.6      |        | 0.6      |        |      |
|                 |                            | CLKEN after CLK↑       | Data low  | 0.5      |        | 0.5      |        |      |

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### switching characteristics over recommended operating free-air temperature range, $C_L$ = 30 pF, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

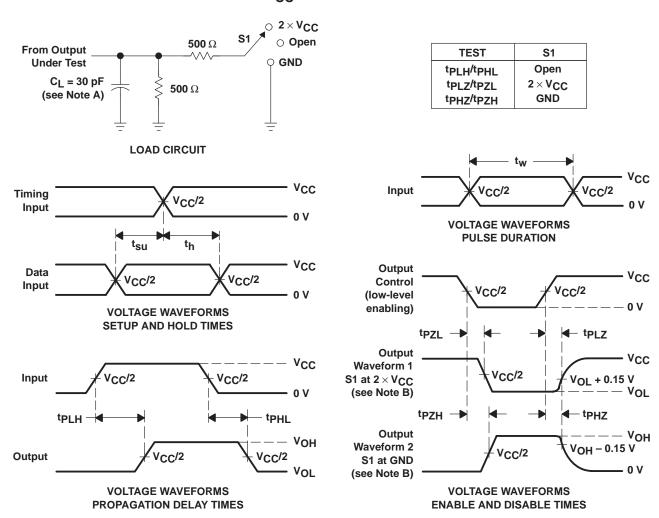
| PARAMETER        | FROM           | то       | SN54ALV | ГН16601     | SN74ALVT | H16601 | UNIT |
|------------------|----------------|----------|---------|-------------|----------|--------|------|
| PARAMETER        | (INPUT)        | (OUTPUT) | MIN     | MAX         | MIN      | MAX    | UNIT |
| fmax             |                |          | 150     |             | 150      |        | MHz  |
| t <sub>PLH</sub> | B or A         | A or B   | 1.1     | <u>4</u> .1 | 1.1      | 4.1    | ns   |
| t <sub>PHL</sub> | D OI A         | AOID     | 1.6     | 4.8         | 1.6      | 4.8    | 115  |
| <sup>t</sup> PLH | LEBA or LEAB   | A or B   | 2.1     | 5           | 2.1      | 5      | ns   |
| <sup>t</sup> PHL | LEDA OI LEAD   | AOID     | 2.4     | 5.4         | 2.4      | 5.4    | 115  |
| <sup>t</sup> PLH | CLKBA or CLKAB | A or B   | 2       | 5           | 2        | 5      | ns   |
| t <sub>PHL</sub> | CLNBA OF CLNAB | AOIB     | 2.5     | 5.9         | 2.5      | 5.9    | 115  |
| <sup>t</sup> PZH | OEBA or OEAB   | A or B   | 2 1.2   | 4.8         | 1.2      | 4.8    | ns   |
| t <sub>PZL</sub> | OEBA OF OEAB   | AUID     | 1       | 4.6         | 1        | 4.6    | 115  |
| <sup>t</sup> PHZ | OEBA or OEAB   | A or B   | 1.2     | 5.2         | 1.2      | 5.2    | ns   |
| tPLZ             | OEBA OI OEAB   | AOID     | 1       | 3.9         | 1        | 3.9    | 113  |

## switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 2)

| PARAMETER        | FROM           | то       | SN54ALV | ГН16601     | SN74ALVT | H16601 | UNIT |
|------------------|----------------|----------|---------|-------------|----------|--------|------|
| PARAMETER        | (INPUT)        | (OUTPUT) | MIN     | MAX         | MIN      | MAX    | UNIT |
| fmax             |                |          | 150     |             | 150      |        | MHz  |
| t <sub>PLH</sub> | D A            | A or B   | 1.4     | <b>3</b> .9 | 1.4      | 3.9    | 20   |
| t <sub>PHL</sub> | B or A         | AUID     | 1.1     | 3.9         | 1.1      | 3.9    | ns   |
| t <sub>PLH</sub> | LEBA or LEAB   | A or B   | 2       | 4.6         | 2        | 4.6    | ns   |
| t <sub>PHL</sub> | LEBA OF LEAB   | AUIB     | 2.1     | 4.6         | 2.1      | 4.6    | 115  |
| <sup>t</sup> PLH | CLKBA or CLKAB | A or B   | 1.9     | 4.5         | 1.9      | 4.5    | ns   |
| <sup>t</sup> PHL | CLNBA OI CLNAB | AOIB     | 2.2     | 4.6         | 2.2      | 4.6    | 115  |
| <sup>t</sup> PZH | OEBA or OEAB   | A or B   | Q 1     | 4.2         | 1        | 4.2    | ns   |
| t <sub>PZL</sub> | OEBA OF OEAB   | AUID     | 1       | 4.4         | 1        | 4.4    | 110  |
| <sup>t</sup> PHZ | OEBA or OEAB   | A or B   | 1.8     | 5.3         | 1.8      | 5.3    | ns   |
| t <sub>PLZ</sub> | OEDA UT OEAB   | AUIB     | 1.7     | 4.6         | 1.7      | 4.6    | 115  |

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### PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 V \pm 0.2 V$



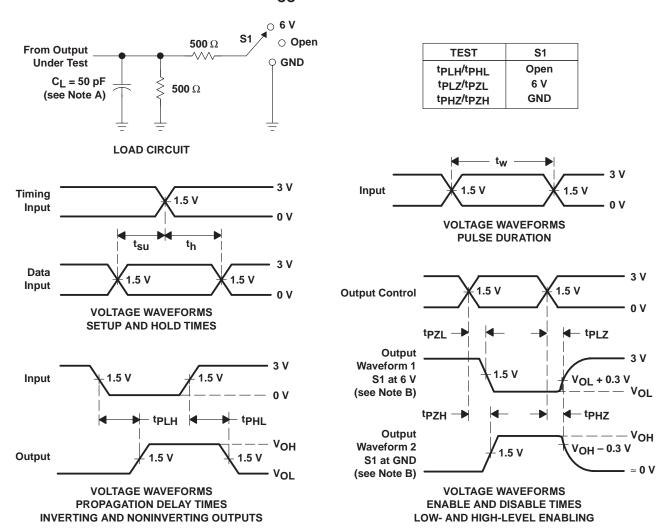
NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_Q = 50 \Omega$ ,  $t_f \leq$  2 ns,  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



### PARAMETER MEASUREMENT INFORMATION $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform22 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_Q = 50 \ \Omega$ ,  $t_f \leq 2.5 \ ns$ .
- D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms





com 18-Sep-2008

#### **PACKAGING INFORMATION**

| Orderable Device  | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup>  | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| 74ALVTH16601DLG4  | ACTIVE                | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH16601DLRG4 | ACTIVE                | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH16601GRE4  | ACTIVE                | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH16601GRG4  | ACTIVE                | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH16601VRE4  | ACTIVE                | TVSOP           | DGV                | 56   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH16601VRG4  | ACTIVE                | TVSOP           | DGV                | 56   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH16601DL  | ACTIVE                | SSOP            | DL                 | 56   | 20             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH16601DLR | ACTIVE                | SSOP            | DL                 | 56   | 1000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH16601GR  | ACTIVE                | TSSOP           | DGG                | 56   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH16601VR  | ACTIVE                | TVSOP           | DGV                | 56   | 2000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
|    | Dimension designed to accommodate the component thickness |
|    | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



### \*All dimensions are nominal

| Device            | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74ALVTH16601DLR | SSOP            | DL                 | 56 | 1000 | 330.0                    | 32.4                     | 11.35   | 18.67   | 3.1     | 16.0       | 32.0      | Q1               |
| SN74ALVTH16601GR  | TSSOP           | DGG                | 56 | 2000 | 330.0                    | 24.4                     | 8.6     | 15.6    | 1.8     | 12.0       | 24.0      | Q1               |
| SN74ALVTH16601VR  | TVSOP           | DGV                | 56 | 2000 | 330.0                    | 24.4                     | 6.8     | 11.7    | 1.6     | 12.0       | 24.0      | Q1               |





\*All dimensions are nominal

| 7.11 dimensione are fromma |              |                 |      |      |             |            |             |
|----------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74ALVTH16601DLR          | SSOP         | DL              | 56   | 1000 | 346.0       | 346.0      | 49.0        |
| SN74ALVTH16601GR           | TSSOP        | DGG             | 56   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74ALVTH16601VR           | TVSOP        | DGV             | 56   | 2000 | 346.0       | 346.0      | 41.0        |

### DL (R-PDSO-G\*\*)

### **48 PINS SHOWN**

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

### DGG (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

### DGV (R-PDSO-G\*\*)

### **24 PINS SHOWN**

### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

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